

### N-Channel 700V (D-S) Super Junction Power MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700			
$R_{DS(on)}$ typ. ( $\Omega$ ) at 25 °C	V <sub>GS</sub> = 10 V	1.0		

#### FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)



# Top View N-Channel MOSFET

TO-252

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage	V <sub>DS</sub>	700	v		
Gate-source voltage	V <sub>GS</sub>	± 30	V		
Continuous drain surrant $(T_{-} = 150 ^{\circ}\text{C})$	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	1	5		
Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )	$T_{\rm C} = 100 ^{\circ}{\rm C}$	ID	3	А	
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	15	1		
Linear derating factor		1.7	W/°C		
Single pulse avalanche energy <sup>b</sup>	E <sub>AS</sub>	390	mJ		
Maximum power dissipation	PD	180	W		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C	50		)//	
Reverse diode dV/dt <sup>d</sup>		dV/dt	5.1	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s		260	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b.  $V_{DD}$  = 100 V, starting  $T_J$  = 25 °C, L = 30 mH,  $R_g$  = 25  $\Omega,~I_{AS}$  = 2A
- c. 1.6 mm from case
- d.  $I_{SD} \leq I_D$ , dI/dt = 100 A/µs, starting  $T_J$  = 25 °C



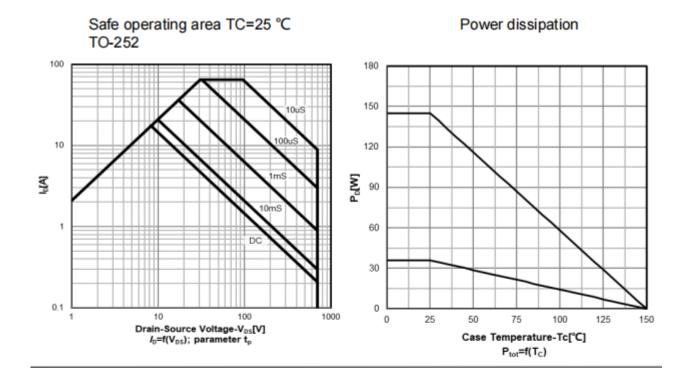
THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62		°C (M)				
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 0.85				- °C/W		
SPECIFICATIONS (T <sub>J</sub> = 25 $^{\circ}$ C, u	Inless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μΑ	700	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	1.08	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> =	250 µA	2.0	-	4.0	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Gate-source leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 30 V		-	-	± 1	μA	
Zere gete veltage drain gurrent	1	V <sub>DS</sub> =	= 700 V, V <sub>C</sub>	<sub>as</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 560 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub>	=1.5A	-	1.0	-	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> :	= 5 A	-	8.7	-	S
Dynamic								
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1600	-	-	
Output capacitance	C <sub>oss</sub>			-	51	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	12	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	44	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	205	-		
Total gate charge	Qg				-	25	-	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 5 \text{ A}, V_{DS} = 480 \text{ V}$		-	8	-	nC	
Gate-drain charge	Q <sub>gd</sub>			-	10	-		
Turn-on delay time	t <sub>d(on)</sub>				-	12	24	
Rise time	t <sub>r</sub>	Voo	= 480 V In	= 5 A	-	14	23	
Turn-off delay time	t <sub>d(off)</sub>	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 5 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$ $f = 1 \text{ MHz, open drain}$		-	61	110	- ns	
Fall time	t <sub>f</sub>			-	16	-		
Gate input resistance	R <sub>g</sub>			0.3	0.7	1.4	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5	^	
Pulsed diode forward current	I <sub>SM</sub>			-	-	15	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 5 A,	V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	416	832	ns
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, $I_F = I_S = 5 A$ , dl/dt = 100 A/µs, $V_R = 25 V$		-	6.4	12.8	μC	
Reverse recovery current	I <sub>RRM</sub>			-	27	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

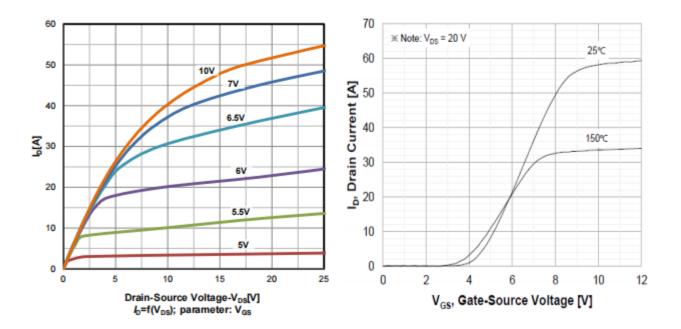


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



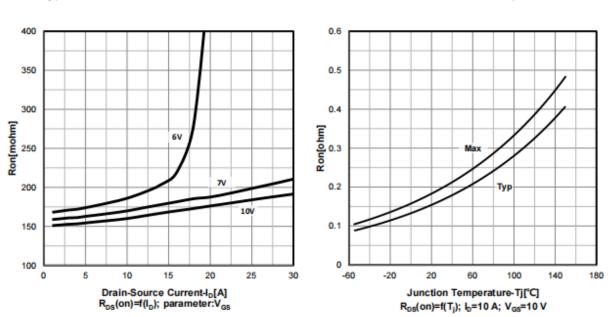
Typ. output characteristics  $T_i=25 \ ^{\circ}C$ 

Transfer characteristics



## **VBE17R05S**

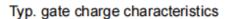


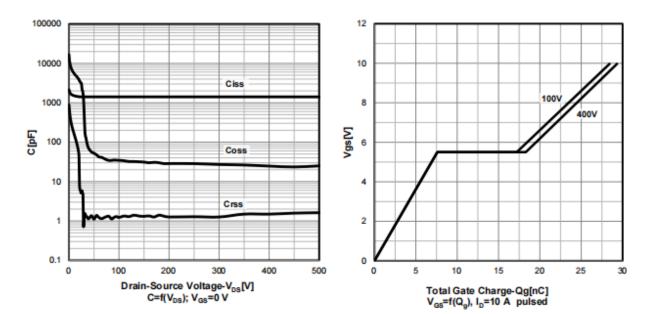


Typ. drain-source on-state resistance

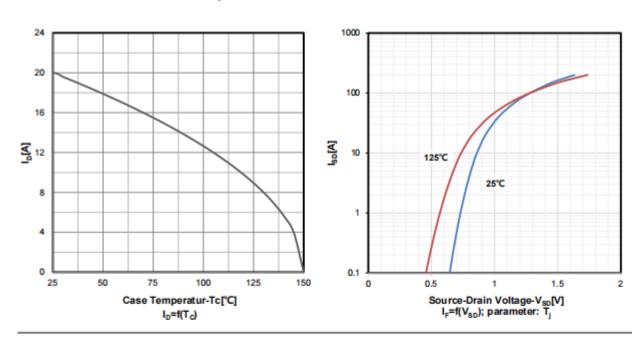
On-resistance vs temperature

Typ. capacitances







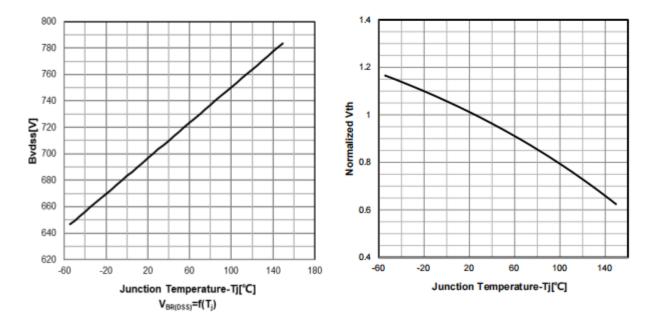


Drain current vs temperature

Forward characteristics of reverse diode

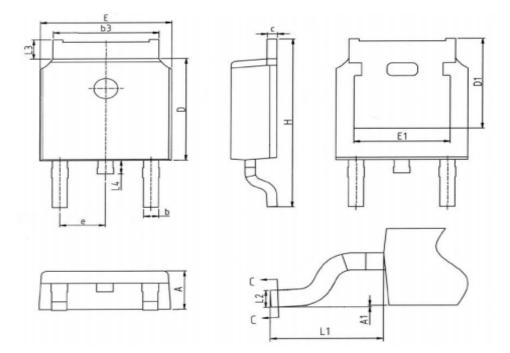
Drain-source breakdown voltage

Normalized VGS(th) characteristics





Package Outline : TO 252



#### COMMON DIMENSIONS

SYMBOL	UNIT(mm)			
SIMBOL	MIN	NOM	MAX	
A	2.20	2.30	2.40	
A1	0.00	-	0.127	
b	0.66	0.78	0.90	
b3	5.16	5.31	5.46	
с	0.43	0.53	0.63	
D	5.98	6.10	6.22	
D1	5.30REF			
E	6.40	6.60	6.75	
E1	4.63	-	-	
е	2.286BSC			
H	9.40	10.10	10.50	
L1	2.90REF			
L2	0.51BSC			
L3	0.88	1.08	1.28	
L4	0.50	0.80	1.00	



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